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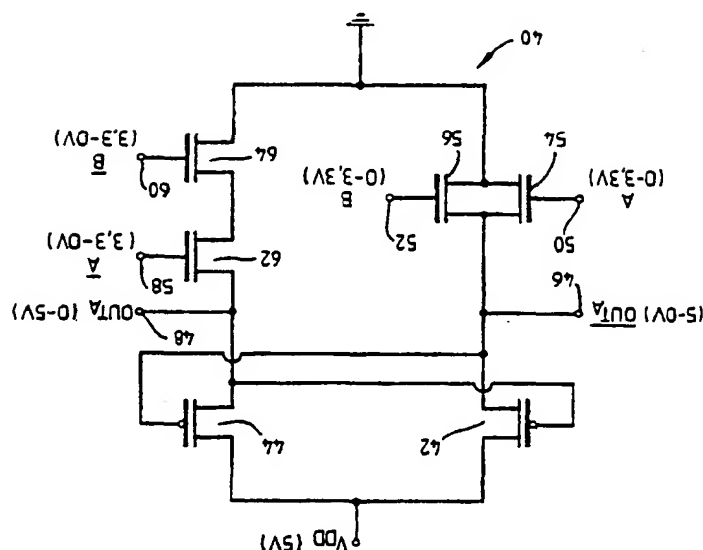
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(54) Cmos level shifting circuit.

(57) A voltage level shifting circuit is used on CMOS integrated circuits. Cross-coupled devices use positive feedback on the gates of 2 P-channel transistors (42,44) to drive one completely off. True and inverted input signals (A,B, A, B) are applied to N-channel transistors (54,56,62,64) connected to the 2

P-channel transistors (42,44), and true and complementary outputs (OUTA, OUTA) are available. N-channel transistors can be combined to perform a logic function in addition to the voltage level function.

Fig. 3.



CMOS LEVEL SHIFTING CIRCUIT

circuit chip, even when 5 volt TTL signals are used between chips. Because of the design of TTL circuits, voltage levels typically switch between 0 and approximately 2.5 volts. This 2.5 volt signal must be boosted to a 3.3 volt signal for on-chip use. The same leakage problem described in connection with Figure 1 can occur on input buffers also, with the P-channel transistor not quite turning off. Other circuits on a chip can also occasionally benefit from using a higher voltage supply. For example, sense amps and other drivers having a high fan-out on the chip can sometimes take advantage of a higher supply voltage in order to improve performance. All of these subcircuits must be driven by an inverter such as shown in Figure 1, or an equivalent circuit, and all will tend to have DC leakage through the P-channel transistor when the input signal to the inverter is zero volts. The more voltage level conversions which must be done on a chip, the greater the DC leakage problem. It would therefore be desirable for a CMOS voltage level shifting circuit to function without a DC leakage current due to incomplete turnoff of the P-channel transistor. It is therefore an object of the present invention to provide a CMOS level shifting circuit which has virtually no leakage current. It is a further object of the present invention to provide such a level shifting circuit which can also operate as a function generator. It is also of the present invention to provide a function generator which provides complementary output functions with or without voltage level shifting. Therefore, according to the present invention, a voltage level shifting circuit has cross-coupled CMOS circuits with complementary inputs. The P-channel transistors are driven completely off using positive feedback, virtually eliminating leakage currents. N-channel transistors can be connected so as to perform various logic functions. The novel features believed characteristic of the invention are set forth in the appended The invention itself however, as well as a preferred mode of use, and further objects and advantages thereof, will best be understood by reference to the following detailed description of an illustrative embodiment when read in conjunction with the accompanying drawings, wherein:

Figure 1 is an illustration of a prior art voltage level shifting CMOS inverter circuit; Figure 2 is a schematic diagram of a voltage level shifting circuit according to the present invention; and

The present invention relates generally to integrated circuits, and more specifically to voltage level shifting and logic functions in CMOS devices. As integrated circuits are fabricated using smaller device sizes, the use of lower on-chip operating voltages is often necessary. These lower voltages are necessitated in part due to hot electron effects which occur when very thin gate oxides are used, and metal electromigration problems which can occur with very small signal traces. For many applications, the electronics industry has standardized around the use of 5 volt TTL logic signals for communication between chips. Because of the problems which occur at smaller geometries, semiconductor manufacturers use lower voltages for on-chip operation for many devices. 3.3 volts is a typical on-chip operating voltage, and lower voltages can be expected as device geometries continue to shrink. A voltage level converter is needed to translate 3.3 volt on-chip levels to the 5 volt levels needed for off-chip signals. Figure 1 illustrates a prior art circuit typically used for this purposes. In Figure 1, an inverter 10 has an input node 12 connected to the gates of a P-channel transistor 14 and an N-channel transistor 16. Output node 18 has the inverted signal of the input signal A. The input on node 12 varies from 0 to 3.3 volts. The supply voltage for the inverter 10 is 5 volts, so the signal on node 18 ideally varies from 0 to 5 volts. When the input signal is 0 volts, transistor 16 is off and transistor 14 is on. This gives an output of 5 volts at node 18. When the input signal is 3.3 volts, transistor 16 is on but P-channel transistor 14 is not turned completely off. This happens because the 5 volt drain voltage is significantly higher than the 3.3 volt gate voltage, which allows leakage current to flow. Although the voltage on node 18 is 0 volts, as required, the leakage current through the inverter in this condition can be as high as 10 to 100 microamps for each inverter 10. In a CMOS circuit with 20 voltage level shifters on 20 output lines, several milliamps of DC current drain occurs during steady state conditions. Since CMOS circuits are designed for use in low power systems, this current drain can be significant and undesirable. For example, some CMOS circuits are designed with built-in battery backups in order to retain their state if system power is lost. With a drain of several milliamps for a single chip, it is possible for these limited capacity backup batteries to be discharged before system power is returned. With some devices, voltage level shifters are needed for signals coming onto an integrated circuit.

tively. Output nodes 46 and 48 correspond to out-

put nodes 36 and 34 respectively.

Input nodes 50 and 52 are connected to the

gates of N-channel transistors 54 and 56 respec-

tively. Input nodes 58 and 60 are connected to the

gates of N-channel transistors 62 and 64 respec-

tively. The logical value of the signal at node 58 is

the complement of the signal at node 50, and the

signal at node 60 is the complement of that at

node 52.

The circuit 40 operates in a manner analogous

to that of circuit 20. If either of the signals A or B

are high (3.3 volts), the corresponding transistor 54

or 56 will be on, bringing the voltage at node 46 to

0. The complementary signal on node 58 or 60 will

be low, causing the corresponding transistor 62 or

64 to be off, causing the voltage at node 48 to go

to 5 volts when the P-channel transistor 44 is

turned-on by the 0 volt signal at node 46. The 5

volt signal at node 48 drives the P-channel transis-

tor 42 off.

It will be appreciated by those skilled in the art

that the voltage at node 46 is equal to the logical

combination $A \cdot B$, while that at node 48 is equal

to $A + B$. With input voltages having a maximum

level of 3.3 volts, 5 volt output voltages are ob-

tained with no excess leakage through the P-chan-

nel transistors 42 or 44.

Circuit 40 can be used to generate a function

and its complement even without the level shifting

feature shown in Figure 3. This would occur when

the input voltages range from 0 to V_{DD} . Such a

function generator circuit requires true and com-

plement signals for all inputs, and generates an

output function and its complement, either or both

of which may be used as desired. When circuit 40

is used as a voltage level shifting circuit, the last

logic stage before the acquired level shift can be

incorporated as shown in Figure 3, and very few or

no extra transistor elements are required to per-

form the level shifting function.

As shown in Figure 3, standard N-channel

logic design techniques can be used to generate

functions of any desired complexity. It is only nec-

essary that the functions performed by the left and

right side of the circuit 40 be truly complementary.

If this were not the case, one or more possible

input states will turn on both P-channel transistors

42 and 44, and create a large current flow to

ground.

As is known in the art, fabrication of P-channel

transistors is more difficult than fabrication of N-

channel transistors, and the resulting P-channel

transistors require more surface area on the in-

tegrated circuit. Therefore, a circuit such as shown

in Figure 3 which combines a logic function with

the use of only two P-channel transistors results in

a functional block which is easily fabricated and

Figure 3 is a schematic diagram of a volt-

age level shifting circuit according to the present

invention which includes output function generation.

As described in the background, Figure 1

shows a prior art inverter used for voltage level

shifting in CMOS circuits. Such prior art circuits

have a significant DC current leakage when the

input voltage at node 12 is 3.3 volts for the reasons

described above.

Referring to Figure 2, a voltage level shifting

circuit which does not suffer from significant DC

current leakage due to an incompletely turned-off

P-channel transistor is shown. The circuit 20 has

complementary inputs 22 and 24 connected to N-

channel transistors 26 and 28 respectively. P-chan-

nel transistors 30, 32 are connected to N-channel

transistors 26, 28 respectively, and to a 5 volt

supply V_{DD} .

Node 34 is the node between transistors 28

and 32, and is an output signal having the same

logic state as the input signal at node 22. Node 36

is the connection between transistors 26 and 30,

and is an output signal having the same logic state

as the input signal at node 24. The gate of transis-

tor 30 is connected to node 34, and the gate of

transistor 32 is connected to node 36.

As will be appreciated by those skilled in the

art, the circuit 20 acts in a manner similar to a

latch, with positive feedback to the gates of transis-

tors 30 and 32. When the input A is low, the input

A is high. Under these conditions, transistor 26 will

be turned off, with transistor 28 turned on. This

brings the voltage at node 34 to ground potential,

turning transistor 30 on. With transistor 30 on and

transistor 26 off, the voltage at node 36 is equal to

V_{DD} , which is shown as 5 volts in Figure 2. This

voltage at node 36 turns transistor 32 off. Since a 5

volt signal is being used to turn off transistor 32,

instead of a 3.3 volt signal such as was the case in

Figure 1, transistor 32 turns completely off.

Thus, when the input at node 22 is low and the

input at node 24 is high, transistors 26 and 32 are

turned completely off. Thus, there is no undesired

leakage current due to an incompletely turned off

P-channel transistor.

When the input at node 22 is high, and the

input at node 24 is low, the circuit 20 operates in

an analogous manner. Under these conditions, tran-

sistor 30 will be turned off by a 5 volt signal and

transistor 28 will be turned off by a 0 volt signal.

Thus, the voltage at node 34 will be 5 volts, and

the voltage at node 36 will be 0 volts.

Referring to Figure 3, an alternative embod-

iment which can operate as a function generator as

well as a voltage shifter is shown as circuit 40. The

upper part of circuit 40 operates in the same man-

ner as that of circuit 20. P-channel transistors 42

and 44 correspond to transistors 30 and 32 respec-

ductivity type is N-type.

12. The circuit of Claim 8, wherein the first conductivity type is P-type and the second conductivity type is N-type.

11. The circuit of Claim 9, wherein the first maximum voltage of approximately 3.3 volts, and the input signals have a maximum voltage less than approximately 3.3 volts.

10. The circuit of Claim 9, wherein the first voltage is 5 volts, and the input signals have a maximum voltage of approximately 3.3 volts.

9. The circuit of Claim 8, wherein the input signals have a maximum voltage which is less than the first voltage.

8. A voltage level shifting circuit, comprising: a first field effect transistor having a channel of a first conductivity type connected to a voltage source and a first output signal node; a second field effect transistor having a channel of the first conductivity type connected to the voltage source and a second output signal node; a logic function connected to the first output signal node and for a reference potential; and a second set of field effect transistors having channels of a second conductivity type, said second set defining a logic function complementary to the first set logic function, and connected to the second output signal node and to the reference potential; wherein a gate of the first transistor is connected to the second output signal node and a gate of the second transistor is connected to the first output signal node; and further wherein the voltage source provides a first voltage, and input signals coupled to gates of transistors in said first and second sets have a maximum voltage which is different from the first voltage.

7. The circuit of Claim 5, wherein set first set and said second set each contain at least two transistors.

6. The circuit of Claim 1, wherein the first conductivity type is P-type, and the second conductivity type is N-type.

5. The circuit of Claim 1, wherein the first output signal node, and a gate of the first transistor is connected to the second output signal node, and a gate of the second transistor is connected to the first output signal node.

4. A voltage level shifting circuit, comprising: a first field effect transistor having a channel of a first conductivity type connected to a voltage source and a first output signal node; a second field effect transistor having a channel of the first conductivity type connected to the voltage source and a second output signal node; a logic function connected to the first output signal node and for a reference potential; and a second set of field effect transistors having channels of a second conductivity type, said second set defining a logic function complementary to the first set logic function, and connected to the second output signal node and to the reference potential; wherein a gate of the first transistor is connected to the second output signal node and a gate of the second transistor is connected to the first output signal node; and further wherein the voltage source provides a first voltage, and input signals coupled to gates of transistors in said first and second sets have a maximum voltage which is different from the first voltage.

Claims

1. A voltage level shifting circuit, comprising: a first field effect transistor having a channel of a first conductivity type connected to a voltage source and a first output signal node; a second field effect transistor having a channel of the first conductivity type connected to the voltage source and a second output signal node; a logic function connected to the first output signal node and for a reference potential; and a second set of field effect transistors having channels of a second conductivity type, said second set defining a logic function complementary to the first set logic function, and connected to the second output signal node and to the reference potential; wherein a gate of the first transistor is connected to the second output signal node and a gate of the second transistor is connected to the first output signal node; and further wherein the voltage source provides a first voltage, and input signals coupled to gates of transistors in said first and second sets have a maximum voltage which is different from the first voltage.

2. The circuit of Claim 1, wherein the first conductivity type is P-type, and the second conductivity type is N-type.

3. The circuit of Claim 1, wherein the voltage source is 5 volts, and input signals coupled to gates of said third and fourth transistors are less than approximately 3.3 volts.

4. The circuit of Claim 1, wherein the voltage source is approximately 3.3 volts, and input signals coupled to gates of said third and fourth transistors are less than approximately 3.3 volts.

5. A CMOS function circuit, comprising: a first field effect transistor having a channel of a first conductivity type connected to a voltage source and a first output signal node; a second field effect transistor having a channel of the first conductivity type connected to the voltage source and a second output signal node; a logic function connected to the first output signal node and for a reference potential; and a second set of field effect transistors having channels of a second conductivity type, said second set defining a logic function complementary to the first set logic function, and connected to the second output signal node and to the reference potential; wherein a gate of the first transistor is connected to the second output signal node and a gate of the second transistor is connected to the first output signal node; and further wherein the voltage source provides a first voltage, and input signals coupled to gates of transistors in said first and second sets have a maximum voltage which is different from the first voltage.

spirit and scope of the invention.

While the invention has been particularly shown and described with reference to a preferred embodiment, it will be understood by those skilled in the art that various changes in form and detail may be made therein without departing from the spirit and scope of the invention.

As described above, the level shifting circuitry of Figures 2 and 3 can be used to drive off-chip output stages, or can be used whenever higher voltage circuitry is needed on a chip. Since both a function and its complement are available as outputs from circuits 20 and 40, metallization can be used to define the function actually applied to an output pin of an integrated circuit chip. This will allow the fabrication of a single basic chip design to be used for different pin function definitions depending on the layout of the metallization mask.

While the invention has been particularly shown and described with reference to a preferred embodiment, it will be understood by those skilled in the art that various changes in form and detail may be made therein without departing from the spirit and scope of the invention.

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13. The circuit of Claim 8, wherein said first set and said second set each contain at least two transistors.

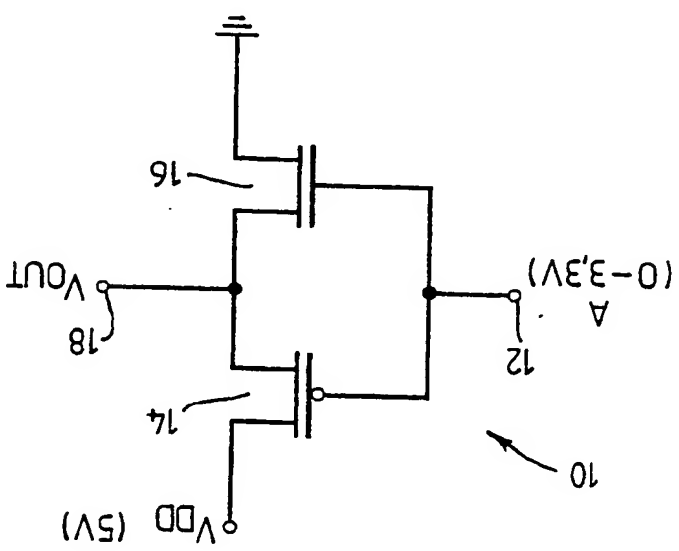


Fig. 1.
(PRIOR ART)

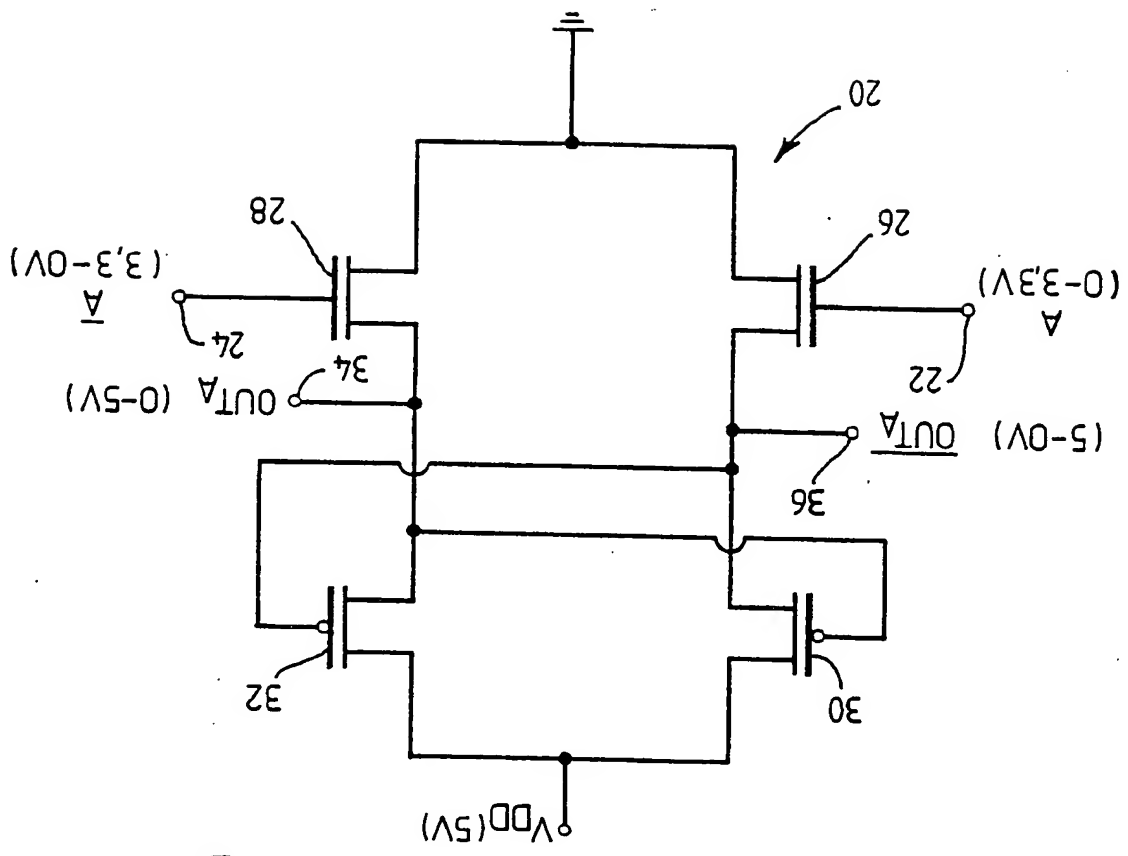


Fig. 2.

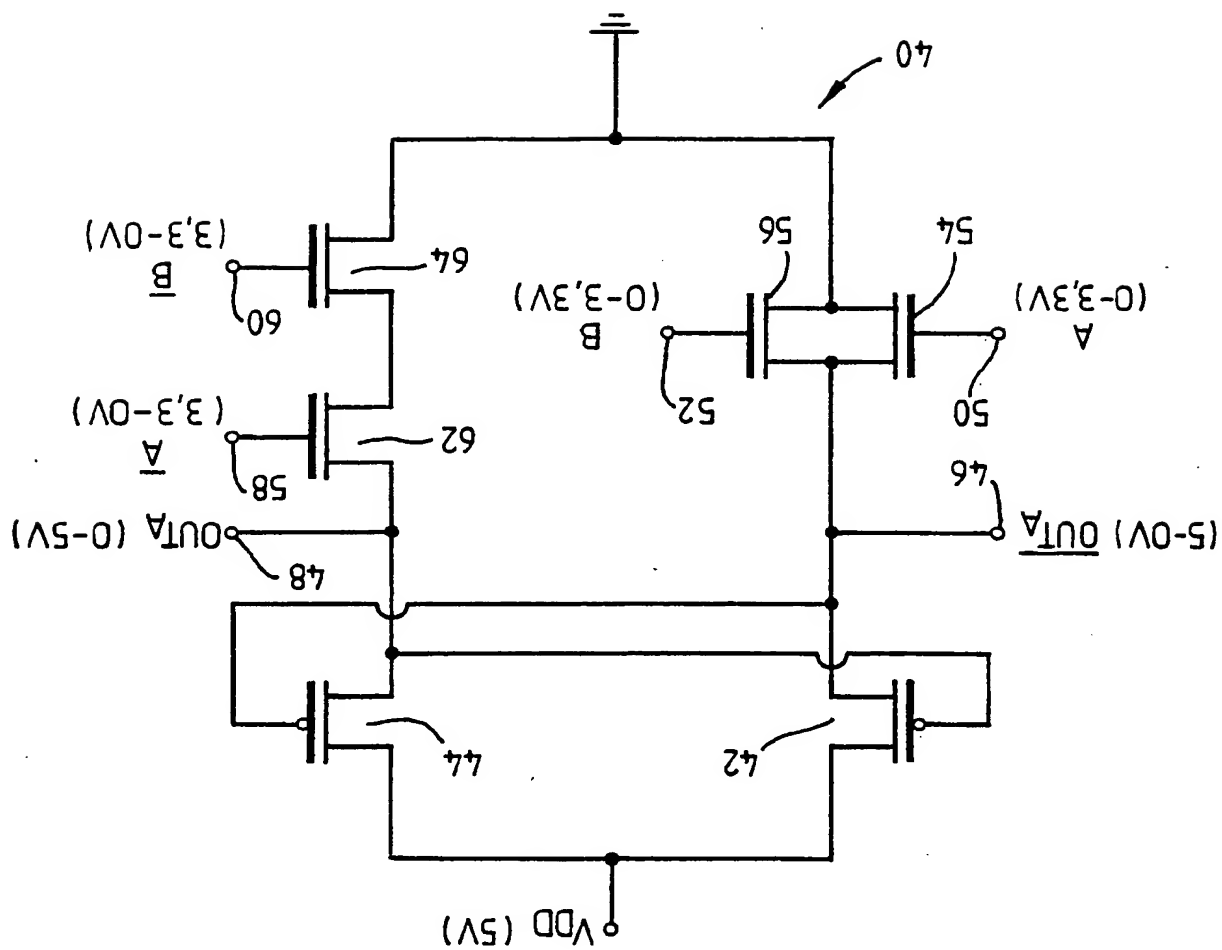


Fig. 3.



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EUROPEAN SEARCH REPORT

Application Number

EP 90 30 2446

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Category	Citation of document with indication, where appropriate, of relevant passages
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A	idem
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P, X	PATENT ABSTRACTS OF JAPAN vol. 13, no. 350 (E-800)(3698), 7 August 1989; & JP - A - 109824 (NEC CORPORATION) 26.04.1989
X	US-A-4 314 166 (O.H. BISMARCK) * figure 1; column 2, line 17 - column 3, line 24 * --- -/-
The present search report has been drawn up for all claims	
Place of search	
BERLIN	
Date of completion of the search	
29-05-1990	
Examiner	
ARENDET M	
CATEGORY OF CITED DOCUMENTS	
X : particularly relevant if taken alone Y : particularly relevant if combined with another document of the same category A : technological background O : non-written disclosure P : intermediate document T : theory or principle underlying the invention F : earlier patent document, but published on, or after the filing date D : document cited in the application L : document cited for other reasons & : member of the same patent family, corresponding document	

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EUROPEAN SEARCH REPORT

Application Number

Ep 90 30 2446

DOCUMENTS CONSIDERED TO BE RELEVANT	
Category	Citation of document with indication, where appropriate, of relevant passages
X	US-A-3 916 430 (R.C. HEUNER et al.) * figure 1
P, X	DE-A-3 729 925 (SIEMENS AG) * figure 1; abstract *
X	DD-A- 249 363 (VEB ZENTRUM WISSENSCHAFT UND TECHNIK) * figure 1; abstract *
X	IBM TECHNICAL DISCLOSURE BULLETIN Vol. 27, no. 1b, June 1984, pages 657, 658, New York, US; W.J. CRAIG et al.: "CVS Logic Circuit with decoupled outputs" * whole document *
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The present search report has been drawn up for all claims	
Place of search	
BERLIN	
Date of completion of the search	
29-05-1990	
Examiner	
ARENDT M	
CLASSIFICATION OF THE APPLICATION (Int. Cl.5)	
1, 2	
1, 2	
1, 2	
5-7	
5-7	
5-7	
5-7	
TECHNICAL FIELDS SEARCHED (Int. Cl.5)	
CATEGORY OF CITED DOCUMENTS	
X : particularly relevant if taken alone	
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